NXP CBT3253A multiplexer datasheet

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The CBT3253A is a dual 1-of-4 high-speed TTL-compatible FET multiplexer/demultiplexer. The low ON-resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

10E, 20E, S0, and S1 select the appropriate B output for the A-input data. The CBT3253A is characterized for operation from 40 C to +85 C.

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CBT3253A

Dual 1-of-4 FET multiplexer/demultiplexer

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Product data sheet

1. General description

The CBT3253A is a dual 1-of-4 high-speed TTL-compatible FET multiplexer/demultiplexer. The low ON-resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

1OE, 2OE, S0, and S1 select the appropriate B output for the A-input data.

The CBT3253A is characterized for operation from -40 °C to +85 °C.

2. Features and benefits

- \blacksquare 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- Latch-up protection exceeds 100 mA per JEDEC standard JESD78 class II level A
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C

3. Ordering information

Table 1. Ordering information

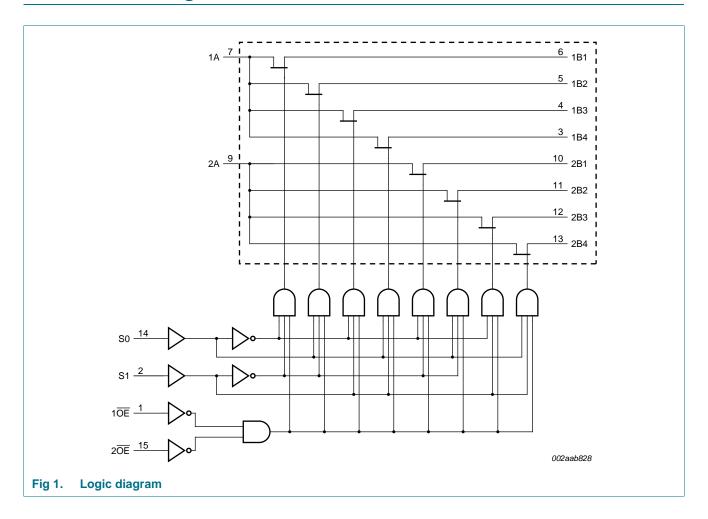
| Type number | Temperature range | Package | Package | | | | | | |
|-------------|-------------------|-----------------------|---|----------|--|--|--|--|--|
| | | Name | Description | Version | | | | | |
| CBT3253AD | –40 °C to +85 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 | | | | | |
| CBT3253ADB | –40 °C to +85 °C | SSOP16 | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 | | | | | |
| CBT3253ADS | –40 °C to +85 °C | SSOP16 ^[1] | plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm | SOT519-1 | | | | | |
| CBT3253APW | –40 °C to +85 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 | | | | | |

^[1] Also known as QSOP16.



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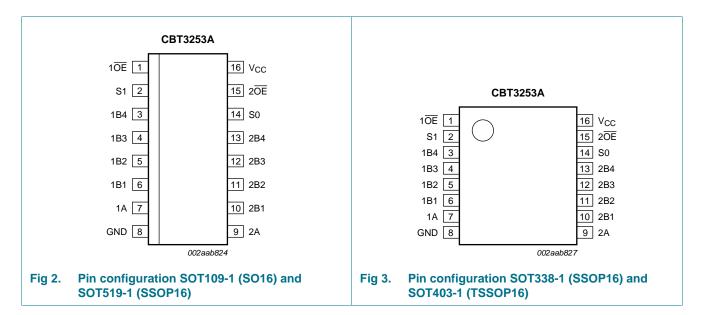
4. Functional diagram



Dual 1-of-4 FET multiplexer/demultiplexer

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------------------------|----------------|----------------------------|
| 1 OE , 2 OE | 1, 15 | output enable (active LOW) |
| S1, S0 | 2, 14 | select control input |
| 1B4, 1B3, 1B2, 1B1 | 3, 4, 5, 6 | 1B outputs/inputs |
| 1A | 7 | 1A input/output |
| GND | 8 | ground (0 V) |
| 2A | 9 | 2A input/output |
| 2B1, 2B2, 2B3, 2B4 | 10, 11, 12, 13 | 2B outputs/inputs |
| V _{CC} | 16 | positive supply voltage |

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6. Functional description

Table 3. Function selection

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

| Inputs | | | | Switch |
|--------|-----|----|----|-------------------------|
| 1OE | 2OE | S1 | S0 | |
| X | Н | X | X | disconnect 1A and 2A |
| Н | X | X | Χ | disconnect 1A and 2A |
| L | L | L | L | 1A to 1B1 and 2A to 2B1 |
| L | L | L | Н | 1A to 1B2 and 2A to 2B2 |
| L | L | Н | L | 1A to 1B3 and 2A to 2B3 |
| L | L | Н | Н | 1A to 1B4 and 2A to 2B4 |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| VI | input voltage | | <u>[1]</u> –0.5 | +7.0 | V |
| I _{SW} | switch current | continuous current through each switch | - | 128 | mA |
| I _{IK} | input clamping current | V _I < 0 V | -50 | _ | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$ | | | |
| | | SO16 package | [2] - | 500 | mW |
| | | SSOP16 package | <u>[3]</u> _ | 500 | mW |
| | | TSSOP16 package | <u>[3]</u> _ | 500 | mW |

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------|--------------------------|-----------------------|-----|-----|------|
| V_{CC} | supply voltage | | 4.5 | 5.5 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | | - | 0.8 | V |
| T_{amb} | ambient temperature | operating in free-air | -40 | +85 | °C |

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^[2] For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

^[3] For SSOP16 and TSSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 70 °C.

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9. Static characteristics

Table 6. Static characteristics

 $T_{amb} = -40$ °C to +85 °C.

| Symbol | Parameter | Conditions | | Min | Typ[1] | Max | Unit |
|---------------------|------------------------------------|---|-----|-----|--------|------|------|
| V_{IK} | input clamping voltage | $V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$ | | - | - | -1.2 | V |
| V_{pass} | pass voltage | $V_I = V_{CC} = 5.0 \text{ V}; I_O = -100 \mu\text{A}$ | | 3.6 | 3.9 | 4.2 | V |
| l _l | input leakage current | $V_{CC} = 5.5 \text{ V}; V_{I} = \text{GND or } 5.5 \text{ V}$ | | - | - | ±1 | μΑ |
| I _{CC} | supply current | V_{CC} = 5.5 V; I_O = 0 mA; V_I = V_{CC} or GND | | - | - | 3 | μА |
| ΔI_{CC} | additional supply current | per input; $V_{CC} = 5.5 \text{ V}$; one input at 3.4 V, other inputs at V_{CC} or GND | [2] | - | - | 2.5 | mA |
| Cı | input capacitance | control pins; V _I = 3 V or 0 V | | - | 4.5 | - | pF |
| $C_{io(off)}$ | off-state input/output capacitance | A port; $V_O = 3 \text{ V or } 0 \text{ V}$; $n\overline{OE} = V_{CC}$ | | - | 11.4 | - | pF |
| | | B port; $V_0 = 3 \text{ V or } 0 \text{ V}$; $n\overline{OE} = V_{CC}$ | | - | 3.8 | - | pF |
| C _{io(on)} | on-state input/output capacitance | A port and B port | | - | 18.6 | - | pF |
| R _{ON} | ON resistance | V _{CC} = 4.5 V | [3] | | | | |
| | | $V_{I} = 0 V; I_{I} = 64 mA$ | | - | 5 | 7 | Ω |
| | | $V_{I} = 0 \ V; \ I_{I} = 30 \ mA$ | | - | 5 | 7 | Ω |
| | | $V_I = 2.4 \text{ V}; I_I = 15 \text{ mA}$ | | - | 10 | 15 | Ω |

^[1] All typical values are measured at V_{CC} = 5 V; T_{amb} = 25 °C.

10. Dynamic characteristics

 Table 7.
 Dynamic characteristics

 $T_{amb} = -40$ °C to +85 °C; $V_{CC} = 4.5$ V to 5.5 V; for test circuit, see <u>Figure 6</u>.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------|--------------------------------------|--------------------|------|------|
| t _{pd} | propagation delay | nA to nBn or nBn to nA; see Figure 4 | [1][2] | 0.25 | ns |
| | | Sn to nA; see Figure 4 | [<u>1][2]</u> 1.2 | 6.2 | ns |
| t _{en} | enable time | nOE to nA or nBn; see Figure 5 | ^[2] 1.3 | 6.3 | ns |
| | | Sn to nBn; see Figure 5 | <u>[2]</u> 1.4 | 6.4 | ns |
| t _{dis} | disable time | nOE to nA or nBn; see Figure 5 | [<u>2</u>] 1.1 | 7.2 | ns |
| | | Sn to nBn; see Figure 5 | <u>[2]</u> 1.0 | 7 | ns |

^[1] This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical ON resistance of the switch and a load capacitance, when driven by an ideal voltage source (zero output impedance).

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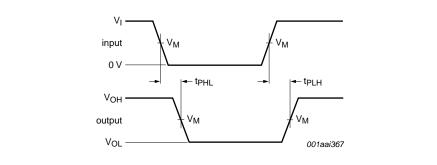
^[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

^[3] Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. The lowest voltage of the two (A or B) terminals determines the ON resistance.

 $[\]begin{array}{ll} \text{[2]} & t_{\text{PLH}} \text{ and } t_{\text{PHL}} \text{ are the same as } t_{\text{pd.}} \\ & t_{\text{PZL}} \text{ and } t_{\text{PZH}} \text{ are the same as } t_{\text{en.}} \\ & t_{\text{PLZ}} \text{ and } t_{\text{PHZ}} \text{ are the same as } t_{\text{dis.}} \\ \end{array}$

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11. AC waveforms



Measurement points are given in Table 8.

 $V_{\mbox{\scriptsize OL}}$ and $V_{\mbox{\scriptsize OH}}$ are typical voltage output levels that occur with the output load.

Fig 4. The input (nA; nBn) to output (nBn; nA) or input (Sn) to output (nA) propagation delay times

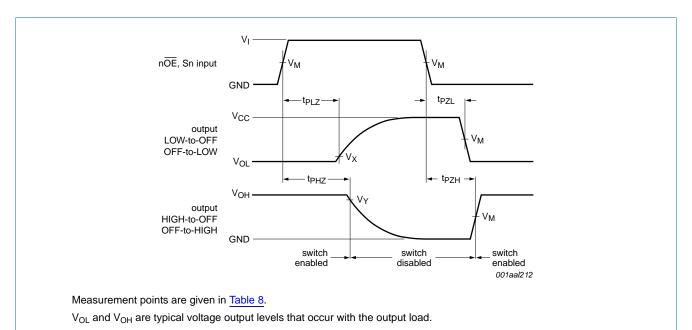


Fig 5. Enable and disable times

Table 8. Measurement points

| Supply voltage | Input | | Output | | | |
|-----------------|--------------|----------------|----------------|-------------------------|------------------|--|
| V _{CC} | VI | V _M | V _M | V _X | V _Y | |
| 4.5 V to 5.5 V | GND to 3.0 V | 1.5 V | 1.5 V | V _{OL} + 0.3 V | $V_{OH} - 0.3 V$ | |

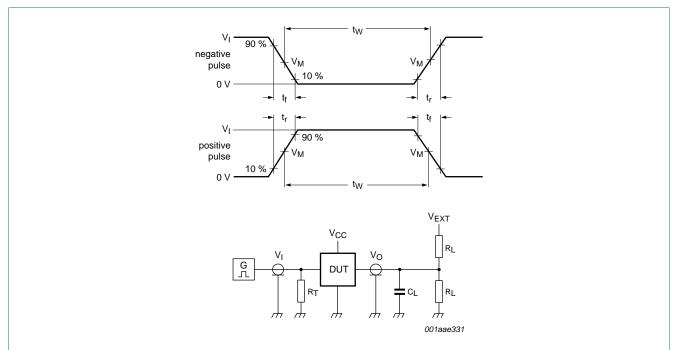
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12. Test information



Test data is given in Table 9.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 6. Test circuit for measuring switching times

Table 9. Test data

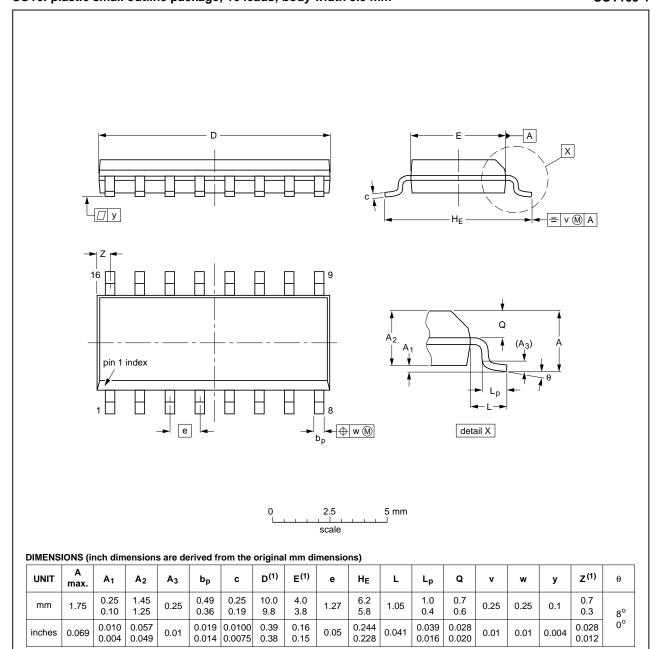
| Supply voltage | Input | | Load | | V _{EXT} | | | |
|-----------------|--|---------------|-------|--------------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| V _{CC} | V _I t _r , t _f | | CL | R_L | t _{PLH} , t _{PHL} | t _{PLZ} , t _{PZL} | t _{PHZ} , t _{PZH} | |
| 4.5 V to 5.5 V | GND to 3.0 V | \leq 2.5 ns | 50 pF | 500Ω | open | 7.0 V | open | |

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13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

^{1.} Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE | | REFER | ENCES | EUROPEAN | ICCUE DATE | |
|----------|--------|--------|-------|------------|---------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE | |
| SOT109-1 | 076E07 | MS-012 | | | 99-12-27 03-02-19 | |

Fig 7. Package outline SOT109-1 (SO16)

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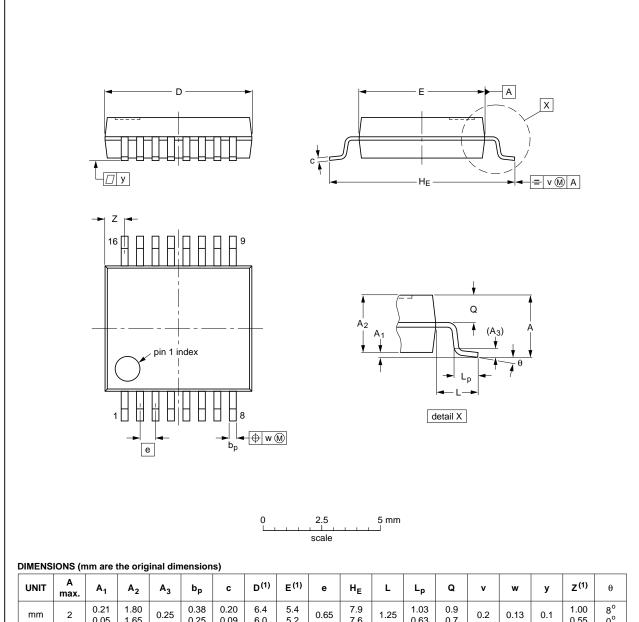
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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.00 0.55 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | ENCES | EUROPEAN | ISSUE DATE |
|----------|-----|--------|-------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | ISSUE DATE |
| SOT338-1 | | MO-150 | | | 99-12-27 03-02-19 |

Package outline SOT338-1 (SSOP16) Fig 8.

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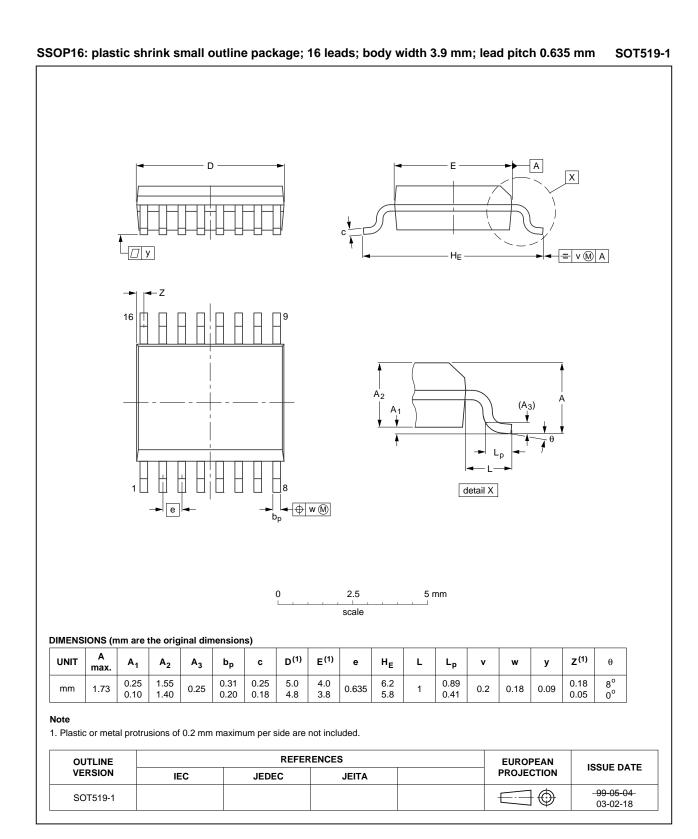


Fig 9. Package outline SOT519-1 (SSOP16)

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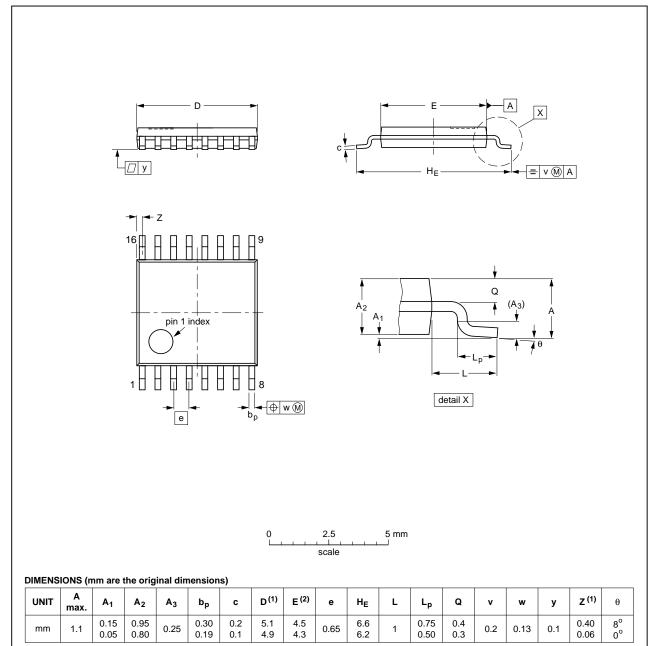
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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | REFERENCES | | | | EUROPEAN | ISSUE DATE |
|----------|------------|--------|-------|--|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT403-1 | | MO-153 | | | | 99-12-27 03-02-18 |

Fig 10. Package outline SOT403-1 (TSSOP16)

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14. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|-----------------------------|
| CDM | Charged Device Model |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|-----------------|-----------------------------------|----------------------|--------------|
| CBT3253A v.3 | 20130924 | Product data sheet | - | CBT3253A v.2 |
| Modifications: | • Table 6 "Stat | ic characteristics" values for pa | ss voltage modified. | |
| CBT3253A v.2 | 20070208 | Product data sheet | - | CBT3253A v.1 |
| CBT3253A v.1 | 20051024 | Product data sheet | - | - |

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|--------------------------------|-------------------|---|
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